

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2652178

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JIE CHEN</td> <td>12/12/2013</td> </tr> <tr> <td>HSIEN-WEI CHEN</td> <td>12/12/2013</td> </tr> </tbody> </table>		Name	Execution Date	JIE CHEN	12/12/2013	HSIEN-WEI CHEN	12/12/2013
Name	Execution Date						
JIE CHEN	12/12/2013						
HSIEN-WEI CHEN	12/12/2013						
RECEIVING PARTY DATA							
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.						
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK,						
City:	HSINCHU						
State/Country:	TAIWAN						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14109192</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14109192		
Property Type	Number						
Application Number:	14109192						
CORRESPONDENCE DATA							
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Date:	12/17/2013						
Total Attachments: 2 source=US2967-ASSG#page1.tif source=US2967-ASSG#page2.tif							

OP \$40.00 14109192

**ASSIGNMENT**

WHEREAS, I(we), CHEN, JIE and CHEN, HSIEN-WEI, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

**SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF**

(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent /Utility Patent is executed on even date herewith unless at least one of the following is checked:

- United States Design Patent was  
 executed on:  
 filed on: Serial No.:  
 established by PCT International Patent Application No.: filed: designating the  
 United States of America  
 issued on \_\_\_\_\_ as U.S. Patent No.: \_\_\_\_\_

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD., whose post office address is NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK, HSINCHU, TAIWAN, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Assignor Name CHEN, JIE	Address NO.32, 5F, MING-TE ROAD, HSINTIEN DISTRICT, NEW TAIPEI CITY, TAIWAN (R.O.C.)
Signature of Assignor Jie Chen	Date of Signature 2013.12.12
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name CHEN, HSIEN-WEI	Address 9F.-3, NO.213, GUANXIN RD., EAST DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
✓ Signature of Assignor Hsien-Wei Chen	✓ Date of Signature 2013.12.12
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)